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## ABSTRACT OF THE DISCLOSURE

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A method for making a semiconductor device having a pattern of highly doped regions (6, 6') located some distance apart in a semiconductor substrate (1) and regions (7, 7', 7") of low doping located between the highly doped regions (6, 6'). A diffusion barrier material (5, 5', 5") is applied to the semiconductor substrate at the location of the regions of low doping by imprinting with the barrier material in the pattern of the regions of low doping. The doping material is applied after or before imprinting with barrier material so that the highly doped regions are formed essentially between material in the substrate. The doping concentrations in the regions of low doping in the highly doped regions can be freely adjusted independently of one another so that a relatively low surface resistance can be obtained for the highly doped regions to give good conducting contact with the metalisation and a high surface resistance can be achieved in the regions of low doping.